



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
		0.99Ω @ V _{GS} = 4.5V	455mA
01	001/	1.2Ω @ V _{GS} = 2.5V	414mA
Q1	20V	1.8Ω @ V _{GS} = 1.8V	338mA
		2.4Ω @ V _{GS} = 1.5V	292mA
		1.9Ω @ V _{GS} = -4.5V	-328mA
	-20V	2.4Ω @ V _{GS} = -2.5V	-292mA
Q2		3.4Ω @ V _{GS} = -1.8V	-245mA
		5Ω @ V _{GS} = -1.5V	-202mA

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

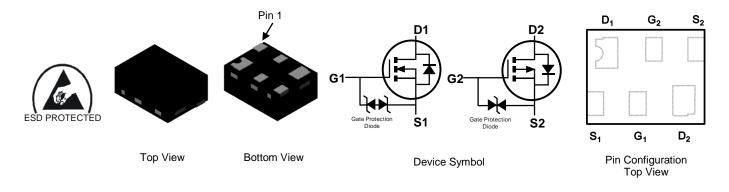
- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

Features and Benefits

- Low On-Resistance
- Very low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 0.8mm x 0.6mm
- Totally Lead-Free & Fully RoHS compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X2-DFN0806-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.027 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMC21D1UDA-7B	X2-DFN0806-6	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



B3 = Product Type Marking Code

Top View



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5)Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$		ID	455 365	mA	
Pulsed Drain Current (Note 6)			I _{DM}	1500	mA

Maximum Ratings Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$ State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		ID	-328 -262	mA	
Pulsed Drain Current (Note 6)			I _{DM}	-1000	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	419	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Notes:

5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			1	1	1	1
Drain-Source Breakdown Voltage	BV _{DSS}	20			V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	IDSS	_	—	1	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_		±10	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	0.75	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
		_	0.5	0.99		$V_{GS} = 4.5V, I_D = 100mA$
Static Drain-Source On-Resistance	Descent	_	0.6	1.2	Ω	$V_{GS} = 2.5 V, I_D = 50 mA$
	R _{DS(ON)}	_	0.8	1.8		$V_{GS} = 1.8V, I_D = 20mA$
			1.0	2.4		$V_{GS} = 1.5V, I_{D} = 10mA$
Diode Forward Voltage	V _{SD}	—	0.6	1.0	V	$V_{GS} = 0V, I_{S} = 10mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	31	_	pF	
Output Capacitance		-	3.6	—	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		2.6	—	pF	1 - 1.00012
Gate Resistance	R _G		113		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg		0.41	—	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Source Charge	Q _{gs}	_	0.06		nC	I _D = 250mA
Gate-Drain Charge	Q _{gd}	-	0.05	—	nC	
Turn-On Delay Time	t _{D(ON)}		4.5	_	ns	
Turn-On Rise Time			3.4	—	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}		24	—	ns	$R_G = 2\Omega$, $I_D = 200mA$
Turn-Off Fall Time	t _F		12	_	ns	



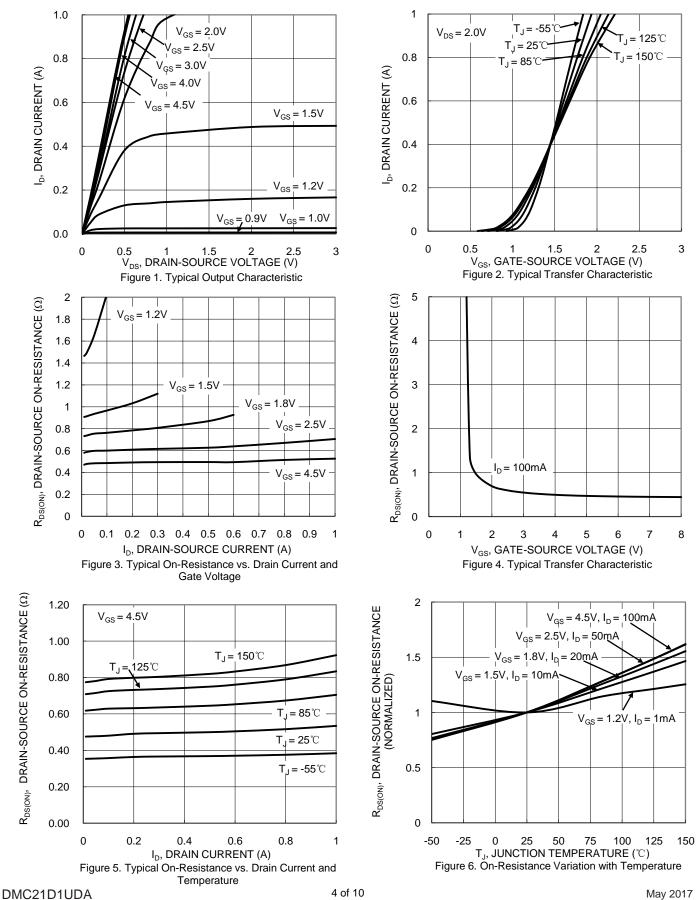
Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	IVIAN	Onit	Test condition
Drain-Source Breakdown Voltage	BV _{DSS}	-20			V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current $@T_{C} = +25^{\circ}C$	IDSS	_		-1	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±10	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)			1		· ·	
Gate Threshold Voltage	V _{GS(TH)}	-0.4	-0.7	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
		_	1.2	1.9		$V_{GS} = -4.5V, I_{D} = -100mA$
Static Drain-Source On-Resistance	D	_	1.6	2.4	Ω	$V_{GS} = -2.5V, I_D = -50mA$
	R _{DS(ON)}	_	1.9	3.4		$V_{GS} = -1.8V, I_D = -20mA$
		_	2.4	5		$V_{GS} = -1.5V, I_D = -10mA$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.1	V	$V_{GS} = 0V, I_{S} = -10mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	28.5		pF	
Output Capacitance	Coss	_	3.9	_	pF	− V _{DS} = -15V, V _{GS} = 0V, − f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.4	_	pF	1 = 1:000112
Gate Resistance	R _G	_	398	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	_	0.4	_	nC	
Gate-Source Charge	Q _{gs}	_	0.07	—	nC	− V _{GS} = -4.5V, V _{DS} = -10V, − I _D = -250mA
Gate-Drain Charge	Q _{gd}	_	0.07	_	nC	ID = -230IIIA
Turn-On Delay Time	t _{D(ON)}		5.2		ns	
Turn-On Rise Time	t _R	_	4.3		ns	V _{DD} = -15V, V _{GS} = -4.5V,
Turn-Off Delay Time			31		ns	$R_{G} = 2\Omega, I_{D} = -200 \text{mA}$
Turn-Off Fall Time	t _{D(OFF)} t _F		15.4	—	ns	

Notes:7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL

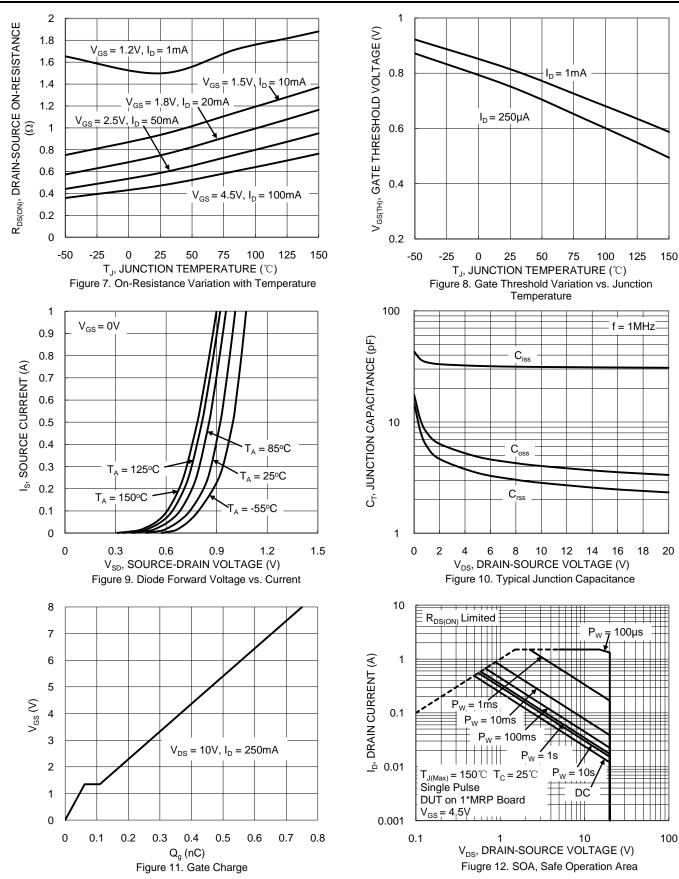


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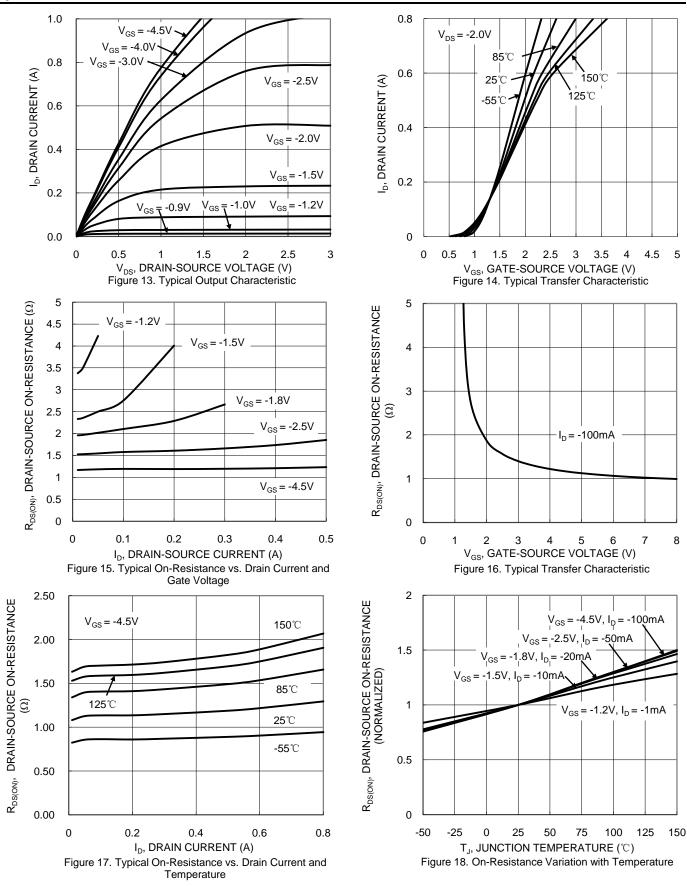
Typical Characteristics - N-CHANNEL (Cont.)



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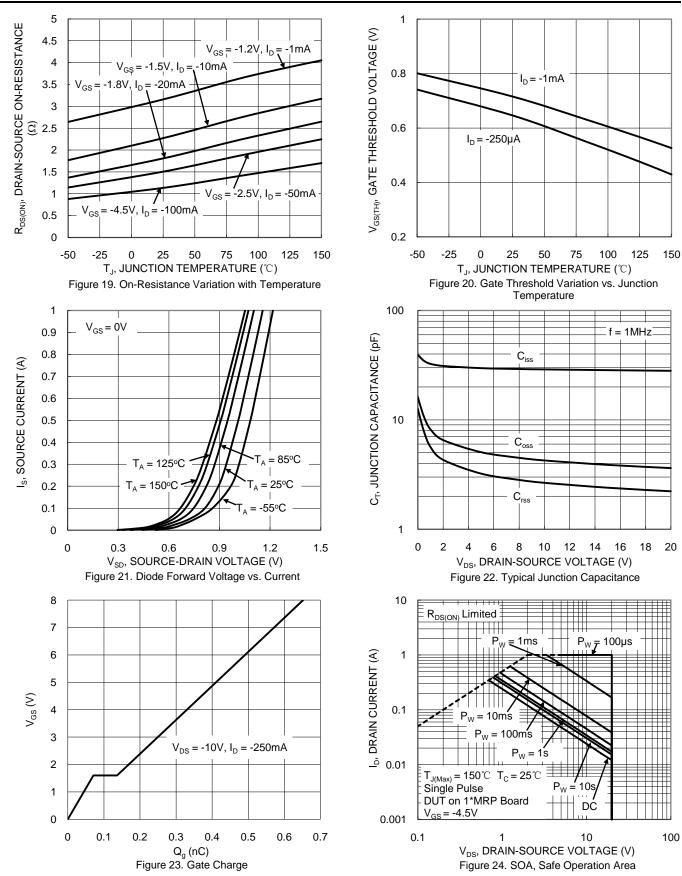


Typical Characteristics - P-CHANNEL



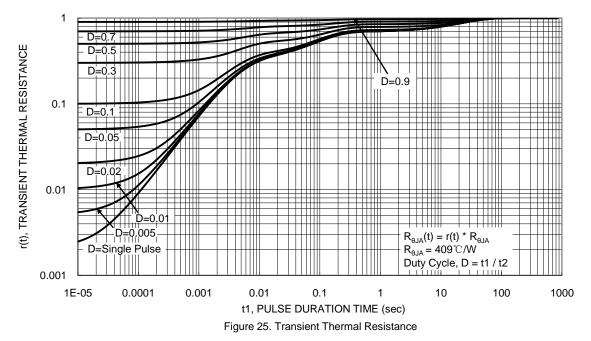


Typical Characteristics - P-CHANNEL (Cont.)



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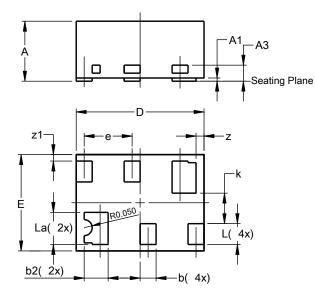




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0806-6

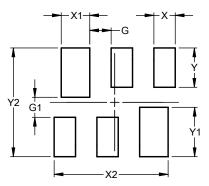


	X2-DFN0806-6						
Dim	Min	Max	Тур				
Α		0.40	0.36				
A1	0.00	0.03	0.02				
A3			0.10				
b	0.07	0.15	0.10				
b2	0.10	0.20	0.15				
D	0.75	0.85	0.80				
E	0.55	0.65	0.60				
е			0.30				
k			0.19				
L	0.10	0.18	0.13				
La	0.17	0.25	0.20				
z			0.05				
z1			0.04				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0806-6



Dimensions	Value (in mm)
G	0.150
G1	0.140
Х	0.150
X1	0.200
X2	0.800
Y	0.275
Y1	0.345
Y2	0.760



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